

50 Watts • 50 Volts • 32us, 2% & MIDS 960-1215 MHz

## **E Class Earless Driver GaN Transistor – Key Features**

- 960-1215MHz 50W Pulsed Output Power 32µS-2% and MIDS Pulsing
- Common Source Class AB 50V Bias Voltage
- >60% Efficiency Across the Frequency Band under MIDS signal
- Extremely Compact Size
- 15.9 dB Typical Power Gain
- 0.3 dB Typical Excellent Gain Flatness
- IFF, Mode-S, DME, TACAN, TCAS, Avionics Secondary Radars
- · All gold metallization and eutectic die attach for highest reliability
- $50\Omega$  in/out lumped element very small footprint plug & play pallets available

### **ABSOLUTE MAXIMUM RATINGS**

#### **Maximum Power Dissipation**

Device Dissipation @ 25°C 100 W

### **Maximum Voltage and Current**

Drain-Source Voltage (VDSS) 150 V Gate-Source Voltage (VGS) -8 to +0 V

## **Maximum Temperatures**

Storage Temperature (TSTG) -55 to +125° C

Operating Junction Temperature +200 °C

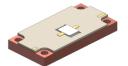
# **CASE OUTLINES Common Source**



0912GN-50LE 55-QQ (0.160"x0.550")



0912GN-50LEL 55-QQP Case (0.160"x0.230")



0912GN-50LEP 0.6"x1.2"x0.150" Pallet

## **ELECTRICAL CHARACTERISTICS @ 25°C**

Symbol	Characteristics	Test Conditions	Min	Тур	Max	Units
P <sub>OUT</sub>	Output Power	P <sub>IN</sub> =1.5W, Freq=960,1090,1215MHz	50	58		W
$G_P$	Power Gain	P <sub>IN</sub> =1.5W, Freq=960,1090,1215MHz	15.2	15.9		dB
$\eta_{D}$	Drain Efficiency	P <sub>IN</sub> =1.5W, Freq=960,1090,1215MHz	58	63		%
Dr	Droop	P <sub>IN</sub> =1.5W, Freq=960,1090,1215MHz		0.4	0.7	dB
VSWR-T	Load Mismatch Tolerance	Po=50W, Freq=1090MHz, 32µ-2%			5:1	

Bias Condition: Vdd=+50V, Idq=20mA constant current (Vgs= -2.0 ~ -4.5V typical)

### **FUNCTIONAL CHARACTERISTICS @ 25°C**

I <sub>D(Off)</sub>	Drain leakage current	$V_{GS} = -8V, V_D = 150V$		4	mA
$I_{G(Off)}$	Gate leakage current	$V_{GS} = -8V$ , $V_D = 0V$		0.5	mA

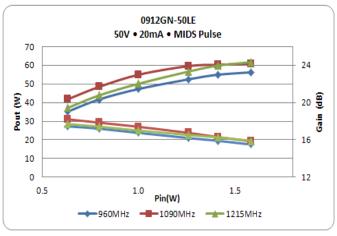
Export Classification: EAR-99

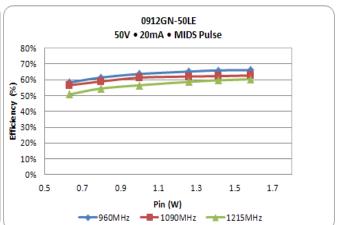


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# TYPICAL PERFORMACE DATA UNDER MIDS (6.4µS on 13µS off, N=256 pulses, DF=21%)

Frequency	P <sub>IN</sub> (W)	P <sub>OUT</sub> (W)	Ι <sub>D</sub> (A)	η <sub>D</sub> @ pulse 1 (%)	Gain (dB)	Droop @ Pulse 256 (dB)
960 MHz	1.6	57	.380	66	15.6	0.30
1090 MHz	1.6	61	.427	63	15.8	0.30
1215 MHz	1.6	62	.449	60	15.9	0.45





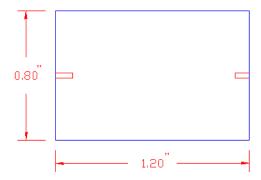
# TYPICAL PERFORMACE DATA UNDER 32µS, DF=2%

Frequency	P <sub>IN</sub> (W)	P <sub>OUT</sub> (W)	I <sub>D</sub> (A)	IRL (dB)	Gain (dB)	Droop (dB)
960 MHz	1.6	58	.039	-12	15.65	0.05
1090 MHz	1.6	62	.044	-7	15.90	0.05
1215 MHz	1.6	63	.046	-5	15.97	0.05



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## 0912GN-50LE/LEL Test Fixture Overall Dimension



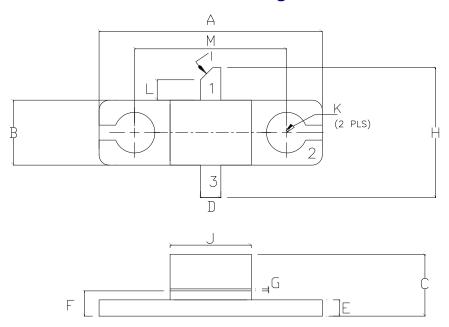
(Dimensions shown are in inches)

# Test Fixture available upon request



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## 0912GN-50LE 55-QQ Package Dimensions



Dim	Millimeter	Tol	Inches	Tol
Α	13.970	0.250	0.550	0.010
В	4.570	0.250	0.160	0.010
С	3.860	0.330	0.152	0.013
D	1.270	0.130	0.050	0.005
Е	1.020	0.130	0.040	0.005
F	1.700	0.130	0.067	0.005
G	0.130	0.025	0.005	0.001
Н	8.130	0.250	0.320	0.010
1	45°	5°	45°	5°
J	5.080	0.250	0.200	0.010
K	2.54 DIA	0.130	.100 DIA	0.005
L	1.270	0.130	0.050	0.005
M	9.530	0.130	0.375	0.005

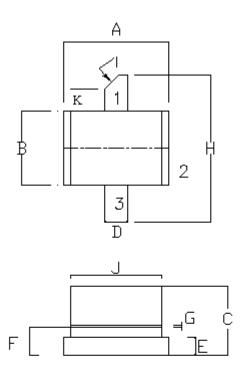
PIN 1: DRAIN PIN 2: SOURCE PIN 3: GATE





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## 0912GN-50LEL 55-QQP Package Dimensions



Dim	Millimeter	Tol	Inches	Tol
Α	5.84	.25	.230	.010
В	4.06	.25	.160	.010
С	3.17	.05	.125	.002
D	1.27	.13	.050	.005
E	1.02	.13	.040	.005
F	1.57	.13	.062	.005
G	.130	.02	.005	.001
Н	8.12	.25	.320	.010
I	45°	5°	45°	5°
J	5.08	.25	.200	.010
K	1.40	.13	.055	.005

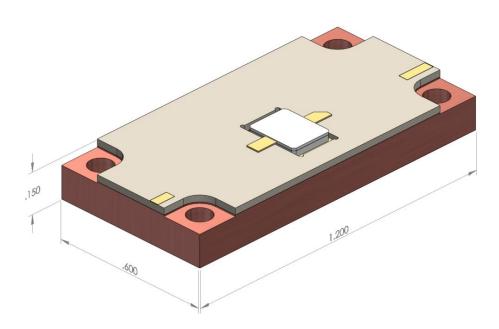
PIN 1: DRAIN PIN 2: SOURCE PIN 3: GATE





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## 90-0912GN-50LEP OVERALL PALLET DIMENSION



Dimension 1.2" X.6"X.15"



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#### Revision History

Revision Level / Date	Para. Affected	Description
0.1 / 19 August 2016	-	Initial Preliminary Release
2 / 7 March 2016	Header, pgs 1, 4, 5, 6	Clarified packaging abiguities